PC	N Nun	nber:	20200206002			PCN Date: Mar		r. 9, 2020		
Title: Datasheet for TUSB1210										
Customer Contact:			PCN Mana	ıger		D		pt:	Quality Services	
Change Type:										
Assembly Site				Design				Wafei	r Bump Site	
Assembly Process					Data Sheet				r Bump Material	
Assembly Materials				Part number change			Wafer Bump Process			
	Mechanical Specification Te			Test Site			Wafer Fab Site			
Packing/Shipping/Labeling			Labeling		Test Process				Wafer Fab Materials	
B						Wafer Fab Process				
Notification Details										
Description of Change: Texas Instruments Incorporated is announcing an information only notification.										
The product datasheet(s) is being updated as summarized below.  The following change history provides further details.  TEXAS INSTRUMENTS  TUSB1210										
SLLSE09I –NOVEMBER 2009 – REVISED DECEMBER 2019										
Changes from Revision H (June 2015) to Revision I										
Changed the document from a data manual format to a TI data sheet format										
Changed RHB Package 32-Pin OFN To: RHB Package 32-Pin ∀QFN in Pin Configuration and Functions										
Changed the HBM value From: ±2 V To : ±2000 V in the ESD Ratings										
	• Changed the $t_{SC}$ , $t_{SD}$ INPUT CLOCK value From: MAX = 3 ns To: MIN = 3 ns in the <i>Timing Requirements</i>									
								_	Requirements11	
Deleted section Via Channel from the Mechanical Packaging and Orderable Information section										
The datasheet number will be changing.										
Device Family					Chan	ige From:		Change To:		
TUSB1210			SLLS	E09H		SLLSE	09I			
These changes may be reviewed at the datasheet links provided.										
http://www.ti.com/product/TUSB1210										
Reason for Change:										
To accurately reflect device characteristics.										
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):										
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.										
Changes to product identification resulting from this PCN:										
None.										
Pro	oduct	Affected:					_			
	TUSB1210BRHBR TUSB1210BRHBT			3RHBT						
					1					

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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